PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
Yasuhiro Tada	07/02/2007	
Akihiko Hanya	07/09/2007	

RECEIVING PARTY DATA

Name:	Stanley Electric Co., Ltd.		
Street Address:	2-9-13 Nakameguro, Meguro-ku		
City:	Tokyo		
State/Country:	JAPAN		
Postal Code:	153-8636		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11761080

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: ST3001-0134

NAME OF SUBMITTER: David J. Kenealy

Total Attachments: 2

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PATENT REEL: 019543 FRAME: 0275

ATTORNEY DOCKET NO.: ST3001-0134 JOINT INVENTION

ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

COMPOSITE SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

for which WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS STANLEY ELECTRIC CO., LTD., a corporation of Japan, whose post office address is 2-9-13 Nakameguro, Meguro-ku, Tokyo 153-8636 Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. 11/761,080 , filed June 11, 2007) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor Yasuhiro TADA	Assignor's Signature Jasuhiro Jada	Date July 2, 2007
Address: c/o 2-9-13, Nakameguro, Meguro-ku, Tokyo 153-8636 JAPAN		<u>Citizenship</u> Japan
Names of additional invento	s []No	

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PATENT REEL: 019543 FRAME: 0276

ATTORNEY DOCKET NO.: ST3001-0134 U.S. Patent Application No.: 11/761,080
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Full Name of Second Assig Akihiko HANYA	nor	Assignor's Signatur		Date July 9.2	D007	
Address: c/o 2-9-13, Nakameguro, Meguro-ku, Tokyo 153-8636 JAPAN					<u>Citizenship</u> Japan	
		•				
Name	es of additional invent	ors attached	[] Yes	[X] No		

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REEL: 019543 FRAME: 0277